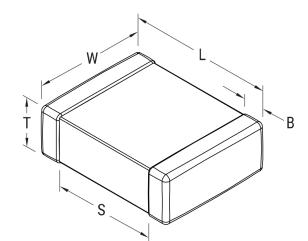


## C0402T332K3RALTU

### Aliases (C0402T332K3RAL7867)

SMD COTS X7R, Ceramic, 3300 pF, 10%, 25 VDC, X7R, SMD, MLCC, COTS, Temperature Stable, Class II, 0402



Click here for the 3D model.

0402
1mm +/-0.05mm
0.5mm +/-0.05mm
0.5mm +/-0.05mm
0.3mm MIN
0.3mm +/-0.1mm

Packaging Specifications		
Packaging	T&R, 1	
Packaging Quantity	10000	

T&R, 180mm, Paper Tape 10000

SeriesSMD COTS X7RStyleSMD ChipDescriptionSMD, MLCC, COTS, Temperature Stable, Class IIFeaturesTemperature Stable, Class IIRoHSNoProp 65 <b>M WARNING:</b> Cancer and reproductive harm - http://www.p65warnings.ca.gov.SCIP Number2d771165-5336-48a3-96fa-3663929fd828TerminationLead (SnPb)MarkingNoFailure RateTesting per MIL-PRF-55681 PDA 8%AEC-Q200NoComponent Weight1.21 mgShelf Life78 Weeks	General Information	1
DescriptionSMD, MLCC, COTS, Temperature Stable, Class IIFeaturesTemperature Stable, Class IIRoHSNoProp 65MARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.SCIP Number2d771165-5336-48a3-96fa-3663929fd828TerminationLead (SnPb)MarkingNoFailure RateTesting per MIL-PRF-55681 PDA 8%AEC-Q200NoComponent Weight1.21 mg	Series	SMD COTS X7R
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RoHSNoProp 65A WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.SCIP Number2d771165-5336-48a3-96fa-3663929fd828TerminationLead (SnPb)MarkingNoFailure RateTesting per MIL-PRF-55681 PDA 8%AEC-Q200NoComponent Weight1.21 mg	Description	SMD, MLCC, COTS, Temperature Stable, Class II
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TerminationLead (SnPb)MarkingNoFailure RateTesting per MIL-PRF-55681 PDA 8%AEC-Q200NoComponent Weight1.21 mg	Prop 65	
Marking No   Failure Rate Testing per MIL-PRF-55681 PDA 8%   AEC-Q200 No   Component 1.21 mg	SCIP Number	2d771165-5336-48a3-96fa-3663929fd828
Failure Rate Testing per MIL-PRF-55681 PDA 8%   AEC-Q200 No   Component 1.21 mg	Termination	Lead (SnPb)
AEC-Q200 No Component 1.21 mg Weight	Marking	No
Component 1.21 mg Weight 1.21 mg	Failure Rate	Testing per MIL-PRF-55681 PDA 8%
Weight I.21 mg	AEC-Q200	No
Shelf Life 78 Weeks		1.21 mg
	Shelf Life	78 Weeks
MSL 1	MSL	1

Specifications	
Capacitance	3300 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	3.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

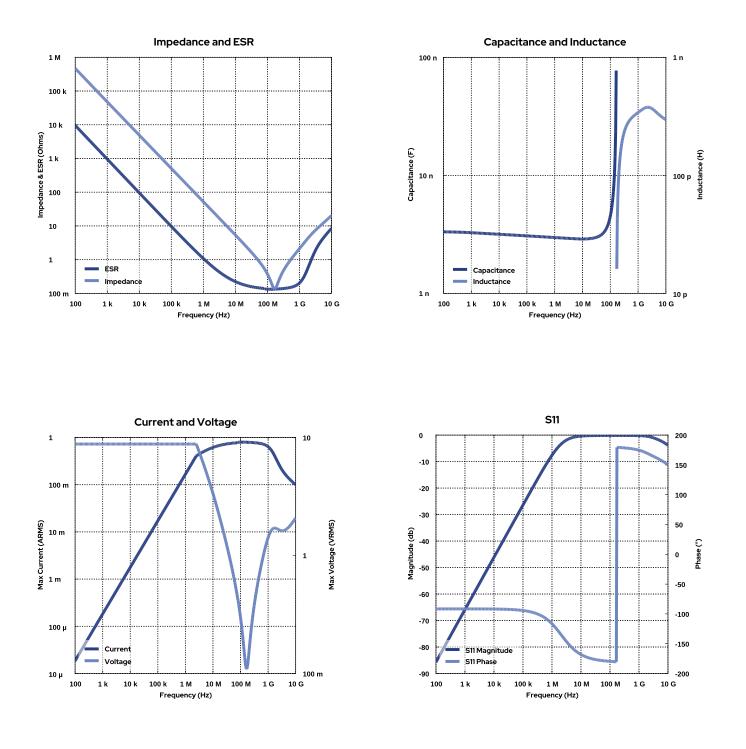


CO402T332K3RALTU Aliases (C0402T332K3RAL7867)

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# Simulations

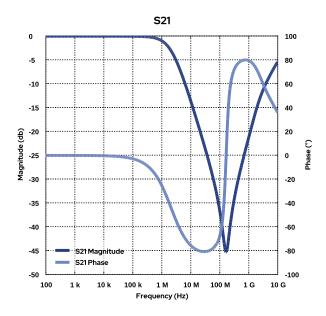
For the complete simulation environment please visit K-SIM.

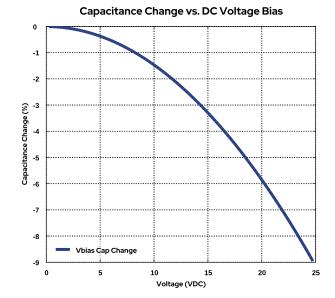




CO402T332K3RALTU Aliases (C0402T332K3RAL7867)

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Capacitance Change versus Temperature 2 0 -2 Capacitance Change (%) -4 -6 -8 -10 -12 -14 Temp Çap Change -16 -60 -40 -20 0 20 40 60 80 100 120 140

Temperature (C)

Capacitance Change versus AC Voltage 4 3 2 Capacitance Change (%) -1 -2 -3 -4 VCAC Cap Change -5 0.5 2 2.5 0 1 1.5 Voltage (VAC)



## C0402T332K3RALTU

#### Aliases (C0402T332K3RAL7867)

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#### These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance. The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.